

ECOC 2008 – Provisional; list of attendees

Aalto	Timo	VTT Technical Research Centre of Finland	Finland
Abbott	Stuart	Tyco Telecom	U.S.A.
ABE	Jun'ichi	NEC Corporation	Japan
Acheroy	Sophie	Royal Military Academy	Belgium
Achiam	Yaakov	CeLight Inc.	U.S.A.
adrienne	gentil	bi	France
Agata	Akira	KDDI R&D Laboratories, Inc.	Japan
Ahlfeldt	Henrik	Proximion Fiber Systems AB	Sweden
Ahmadpanahi	Hamed		Belgium
Aiso	Keiichi	The Furukawa Electric Co., Ltd.	Japan
Akrout	Akram	III-Vlab Alcatel-thales	France
Alan	McCurdy	OFS-Fitel, LLC	U.S.A.
Albores-Mejía	Aarón	COBRA - TUEindhoven	The Netherlands
Alcon Camas	Mercedes	Aston University	United Kingdom
Alemaný	Ruben	Universidad Politecnica de Valencia	Spain
Alferness	Rod	Alcatel-Lucent	U.S.A.
Alfiad	Mohammad	Eindhoven University of Technology	The Netherlands
Amano	Takeru	National Institute of Advanced Industrial Science and Technology (AIST)	Japan
Amos	Neil	Fujitsu Microelectronics Europe	United Kingdom
Anandarajah	Prince	Dublin City University	Ireland (Rep.)
Anderson	Trevor	MDI	Australia
Andrekson	Peter	Photonics Laboratory	Sweden
Ania-Castañón	Juan Diego	Instituto de Óptica Daza de Vlades CSIC	Spain
Antonelli	Cristian		Italy
Apostolopoulos	Dimitrios	Institute of communication and Computer Systems	Greece
Arakawa	Taro	Yokohama National University - Div. Electrical and Computer Engineering	Japan
Arellano	Cristina	VPI systems GmbH	Germany
Argyris	Apostolos	University of Athens	Greece
Ariga	Maiko	The Furukawa Electric Co., Ltd.	Japan
Artundo	Inigo	VRIJE UNIVERSITEIT BRUSSEL	Belgium
Asami	Toru	The University of Tokyo	Japan
Asano	Shoichiro	National Institute of Informatics	Japan
Asobe	Masaki	NTT Photonics Laboratories	Japan
Augé	Jean-Luc	Alcatel-Lucent	France
AUGUSTE	Jean-Louis	XLIM	France
Awadalla	Ahmed	Nortel Networks Technology Corp.	Canada
AWAJI	Yoshinari	National Institute of Information and Communications Technology (NICT)	Japan
Bach	Peter	Ericsson	Denmark
Baekelandt	Bart	Ghent University	Belgium
Baets	Roel	UGent	Belgium
Bagge	Gert		Sweden

Balsamo	Stefano		Italy
Ban	Takuma	Hitachi, Ltd.,	Japan
Baptista	Albano	Instituto de Telecomunicacoes Aveiro	Portugal
Barbier	Denis	Teem Photonics	France
Barry	Liam	Dublin City University	Ireland (Rep.)
Bartels	Jan	MEN@NET TRADE	Germany
Baskiotis	Catherine	Université des Sciences et Technologies de Lille	France
Bastawrous	Hany	Kyushu University	Japan
Bastekar	Lior	Ray-Q	Israel
Batten	Jeremy	Cable & Wireless	United Kingdom
Bauwelinck	Johan	Ghent University - IMEC	Belgium
Bayvel	Polina	University College London	United Kingdom
Beelen	Gunter	Gemfire Europe	Belgium
Bellec	Martial	France Telecom Orange Labs	France
Bellotti	Giovanni	Alcatel-Lucent Italia	Italy
Bendelli	Giampaolo	Avago Technologies	Italy
Benisty	Henri	Institut d'Optique	France
Berger	Matthias	Alcatel-Lucent Deutschland AG	Germany
Berghmans	Francis	Vrije Universiteit Brussel	Belgium
Bergman	Keren	Columbia University	U.S.A.
Berthold	Joseph	CIENA Corp.	U.S.A.
Bertolini	Marco	University of Parma	Italy
Betran Pardo	Oriol	Alcatel-Lucent	France
Bette	Sébastien	Faculté Polytechnique de Mons	Belgium
Bezak	Branislav	T-Com	Slovakia
Bhamber	Ranjeet	Aston University	United Kingdom
Bianchi	Alberto	Ericsson	Italy
Bianciotti	Allesandro		Germany
Biberman	Aleksandr	Columbia University	U.S.A.
Bigo	Sébastien	Alcatel-Lucent	France
Bigot-Astruc	Marianne	Draka Comteq France	France
Birks	Tim	University of Bath	United Kingdom
Blair	Loudon	CIENA Corp.	U.S.A.
Blow	Keith	Aston University	United Kingdom
Blubaugh	Bill		U.S.A.
Blumenthal	daniel	UCSB	U.S.A.
Bockstaele	Ronny	Phocon	Belgium
Boffi	Pierpaolo	Politecnico di Milano	Italy
Bogaerts	Wim	Ghent University - IMEC	Belgium
Bogoni	Antonella	CNIT	Italy
Bogris	Adonis	National and Kapodistrian University of Athens	Greece
Bohn	Marc	Nokia Siemens Networks GmbH & Co KG	Germany
Bolognini	Gabriele	Scuola Superiore Sant'Anna	Italy

Bonada	Francesc	UPC	Spain
Bonk	Rene	University of Karlsruhe	Germany
Bononi	Alberto	University of Parma	Italy
Boone	Wim	Ingenium nv	Belgium
Bornholdt	Carsten	Fraunhofer Institute for Telecommunications	Germany
Bosack	Len	XKL	Market Focus Speaker
Bosco	Gabriella	Politecnico di Torino	Italy
Bosco	Harry	Opnext	Market Focus Speaker
Boscolo	Sonia	Aston University	United Kingdom
Bouda	Martin	Fujitsu Laboratories of America, Inc.	U.S.A.
Bousselet	Philippe	Alcatel-Lucent, Bell Labs	France
Bouwens	Arno		Belgium
Bower	Patricia	Fujitsu Microelectronics Europe GmbH	United Kingdom
Bozorgebrahimi	Kurosh	UNINETT AS	Norway
Bozzi Pietra	Simone	PGT Photonics	Italy
Brainis	Edouard	University of Oxford	United Kingdom
Bramerie	laurent	CNRS FOTON	France
Brans	Toon	UGent	Belgium
Braun	Ralf-Peter	Deutsche Telekom	Germany
Brehm	Lothar	j-fiber GmbH	Germany
Breidne	Magnus	Ignis Photonyx	Market Focus Speaker
Bres	Camille	University of California San Diego	U.S.A.
Breuer	Dirk	Deutsche Telekom AG, T-Systems	Germany
Breyer	Florian	Technische Universität München	Germany
Brilland	Laurent	PERFOS	France
Brodsky	Misha	AT&T Labs	U.S.A.
Brouckaert	Joost	Ghent University - IMEC	Belgium
Buchali	Fred	Alcatel-Lucent Deutschland AG	Germany
Büchter	Daniel	Universität Paderborn	Germany
Bufetov	Igor	FORC	Russian Federation
Bulthuis	Henk	Gemfire	Netherlands
Bunge	Christian-Alexander	Technische Universität Berlin	Germany
Burvall	Magnus		Sweden
Bussmann	Rainer	Harting	Germany
Cai	Lei	Shanghai Jiao Tong University	China
Cakala	Andrzej	Telekomunikacja Polska	Poland
Calabretta	Nicola	Eindhoven University of Technology	The Netherlands
Cameron	James	Phasoptx	Canada
Camisard	Emilie	GIP RENATER	France
Campbell	Joe	University of Virginia	U.S.A.
Campi	Aldo	University of Bologna	Italy
Campuzano	Gabriel	Tecnologico de Monterrey	Mexico
Cano	Ivan	Politecnico di Torino	Italy

Carballar	Alejandro	Universidad de Sevilla	Spain
Carena	Andrea	Politecnico di Torino	Italy
Carrozzo	Gino	Nextworks s.r.l.	Italy
Cartaxo	Adolfo	Instituto de Telecomunicaciones	Portugal
Cartledge	John	Queen's University	Canada
Casellas	Ramon	Centre Tecnològic de Telecomunicacions de Catalunya	Spain
Casier	Koen	Ghent University - IBBT	Belgium
Castanon	Gerardo	Tecnologico de Monterrey	Mexico
Castoldi	Piero	Scuola Superiore Sant'Anna	Italy
Cauwenbergh	Pieter-Jan	Vrije Universiteit Brussel	Belgium
Cavazzoni	Carlo	Telecom Italia	Italy
Cerutti	Isabella	Scuola Superiore Sant'Anna	Italy
Chacinski	Marek	Royal Institute of Technology, KTH	Sweden
Champavere	Andre	JDSU FRANCE SAS	France
Chan	Calvin C K	The Chinese University of Hong Kong	Hong Kong
Chanclou	Philippe	Orange Labs, France Telecom R&D	Market Focus Speaker
Chandy	Rebecca		United Kingdom
Chang	Do-Il	Xtera Comminications	U.S.A.
Chartier	Tierry	FOTON-CNRS	France
Chava	Vijaya Saradhi	Create-Net	Italy
Chbat	Michel	Nokia Siemens Networks	U.S.A.
Che	Woo-Seong	Kyungsung Univ.	Korea
Chen	Ching-Hsien	Chunghwa Telecom. Co., Ltd.	Taiwan R.O.C.
Chen	Chun-Shiow	ITRI	Taiwan R.O.C.
Chen	Hongda	Institute of Semiconductors, Chinese Academy of Sciences	China
Chen	Jason (Jyehong)	National Chiao Tung University	Taiwan R.O.C.
Chen	Ming	Huawei Technologies	Germany
Chen	Xiaomin	IDA	Germany
Chen	Xiongbin	Institute of Semiconductors, Chinese Academy of Sciences	China
Cheng	Ning	Huawei Technologies	U.S.A.
Cheng	Xiaofei	Institute for Infocomm Research	Singapore Rep. of
Chi	Nan	Fudan University	China
Chi Wai	Chow	National Chiao Tung University	Taiwan R.O.C.
Chien	Isabella	Optoway Technology Inc.	Taiwan R.O.C.
Chikuma	Tadayuki	NEC Corporation	Japan
Chiuchiarelli	Andrea	Scuola Superiore S.Anna	Italy
Choudhary	Amol	UGent	Belgium
Chowdhury	Arshad	Georgia Institute of Technology	U.S.A.
Chramosta	Amy	Finisar	U.S.A.
Chraplyvy	Andrew	Bell Labs	U.S.A.
Chu	Sai	Infinera	U.S.A.
Chung	SungHan	Queen's University	Canada
Chung	Yun	KAIST	Korea

Ciaramella	Ernesto	Scuola Superiore Sant'Anna	Italy
Cincotti	Gabriella	University Roma Tre	Italy
Clark	Timothy	SSCP USA	U.S.A.
Clarke	Ian	Optium Australia	Australia
Clermont	Jacques	DWDM Mux/ Demux	France
Clouqueur	Matthieu	Nokia Siemens Networks GmbH & Co. KG	Germany
Coelho	Leonardo	Technische Universität München	Germany
Coldren	Larry	University of California at Santa Barbara	U.S.A.
Colle	Didier	Ghent University - IBBT	Belgium
Collings	Brandon	JDSU	U.S.A.
Cong	Guangwei	National Institute of Advanced Industrial Science and Technology (AIST)	Japan
Coomans	Werner		Belgium
Cucala	Luis	Telefónica Investigación y Desarrollo	Spain
Culshaw	Jessica	BCS PUBLIC RELATIONS	United Kingdom
Curri	Vittorio	Politecnico di Torino	Italy
Cvijetic	Milorad	NEC	U.S.A.
Cvijetic	Neda	NEC Labs America	United States of America
Daerden	Eric	FOS&S	Belgium
Daiber	Andrew	Emcore	United States of America
Danckaert	Jan	Vrije Universiteit Brussel	Belgium
Danielsen	Per	PLDesign	Denmark
Darko	Zibar	Technical University of Denmark	Denmark
De Cock	Olivier	IBBT	Belgium
De Dobbelaere	Peter	Luxtera Inc.	U.S.A.
De Groote	Maarten	Ghent University	Belgium
De Koninck	Yannick	Ghent University	Belgium
de Laat	Cees	Univ Amsterdam	Netherlands
de Laat	Maurice	Genexis	The Netherlands
De Leenheer	Marc	Ghent University - IBBT	Belgium
de Miguel	Ignacio	Ericsson Research	Sweden
de Montmorillon	Louis-Anne	Draka	France
De Paula	Leonardo	INATEL - Instituto Nacional de Telecomunicacoes	Brazil
De Pauw	Piet	Melexis	Belgium
De Ridder	Tine	Ghent University - IMEC	Belgium
De Vleeschouwer	André	IBBT	Belgium
de Waardt	Huugh		The Netherlands
De Waele	Wim	IBBT	Belgium
Debaes	Christof	Vrije Universiteit Brussel	Belgium
Demeester	Piet	IBBT - Universiteit Gent	Belgium
Deng	Binlin	HUAWEI COMPANY	China
Deng	Yanhua	Princeton University	U.S.A.
D'Errico	Antonio	CNIT	Italy
Desthieux	Bertrand	Alcatel-Lucent	Belgium

Develder	Chris	Ghent University - IBBT	Belgium
Devos	Bart	Andlinger & Company CVBA	Belgium
Dezhong	Yu	Huawei	China
Dianov	Evgeny	Fiber Optics Research Center	Russian Federation
Dinu	Raluca	Lumera Corp	United States of America
Dischler	Roman	Alcatel-Lucent Deutschland AG	Germany
Diukman	Anner	IDF ISRAELI DEFENSE FORCES	The Netherlands
Dockney	Michael	Smart Fibres Ltd	United Kingdom
Doering	Heinz	Mittweida University	Germany
Dong	Liang	IMRA America	U.S.A.
Dorissen	Tom		Belgium
Dorren	Harmen	COBRA - TUEindhoven	The Netherlands
Du	Liang	Monash University	Australia
Duan	Guang-Hua		France
Ducros	Nicolas	XLIM	France
Dudley	John	CNRS Institut FEMTO ST	France
Dueser	Michael	Deutsche Telekom AG, T-Systems	Germany
Dummer	Matthew	University of California at Santa Barbara	U.S.A.
Dumon	Pieter	IMEC - Ghent University	Belgium
Duran Barroso	Ramon J	Universidad de Valladolid	Spain
Dussardier	Bernard	Universite de Nice-Sophia Antipolis	France
Dutta	Anjori		Belgium
Dvir	Rafi	Civcom	Israel
Dzah-Dake	Makarios Mokpokpo Kwame	HOPE FOR AFRICA NETWORK	Ghana
Ebikade	Anslem	Willette Services Company Limited	Nigeria
Edirisinghe	Sumudu	Xtera Communication Ltd.	United Kingdom
Ednay	Richard	Optical Technology Training Ltd.	United Kingdom
Ehrhardt	Armin	Deutsche Telekom	Germany
Eimear	MacHale	Tyndall National Institute/University College Cork	Ireland (Rep.)
Eiselt	Michael	ADVA AG Optical Networking	Germany
Elahmadi	Salam	Menara	United States of America
Elbers	Joerg-Peter	ADVA AG Optical Networking	Germany
El-Darawy	Mohamed	Universität Paderborn	Germany
Elena	Sheveleva	High Technology Publishers	Russian Federation
Elias	Igor	Create	Belgium
Ellermeyer	Tobias	MICRAM Microelectronic GmbH	Germany
Ellis	Andrew	Tyndall National Institute	Ireland (Rep.)
El-taher	Atalla	Aston University	United Kingdom
Erasme	Didier	Institut TEECOM - TELECOM ParisTech	France
Essiambre	Rene-Jean	Bell Laboratories, Alcatel-Lucent	U.S.A.
Everett	Jim	Ericsson	United Kingdom
Ezra	Ip	Stanford University	U.S.A.
Fabianek	Bernhard	Euroepan Commission	Belgium

Facchini	Massimo	Brugg Kabel AG	Switzerland
Faccin	Pier	Andrew Wireless Systems	Italy
Faerbert	Andreas	ADVA	Germany
Fan	Xinyu	NTT Corporation	Japan
Fanjoux	Gil	Institut FEMTO-ST, Université de Franche-Comt	France
Farina	Giovanni		Italy
Fatome	Julien	Institut Carnot de Bourgogne (ICB) CNRS-UB Dijon	France
Faure	Jean-Paul	Alcatel-Lucent	France
Feng	Zhiyong	Huawei Technologies Co., Ltd.	China
Ferguson	Alex	University College	Ireland (Rep.)
Fernandez-Palacios	Juan	Telefónica Investigación y Desarrollo	Spain
Ferreira	Ana	Instituto de Telecomunicações	Portugal
Ferrero	Valter	Politecnico di Torino	Italy
Feuillet	Christophe	THALES	France
Figuerola	Sergi	i2CAT FOUNDATION	Spain
Filipin	Tomislav	Croatian Agency for Post and Electronic Communications	Croatia
Fini	John	OFS Labs	U.S.A.
Finkenzeller	Michael	Nokia Siemens Networks	Germany
Fischer	Johannes	Technische Universität Berlin	Germany
Fleming	Simon	The University of Sydney	Australia
Foisel	Hans-Martin	Deutsche Telekom	Germany
Fontaine	Nicolas	University of California	U.S.A.
Forghieri	Fabrizio	Cisco Photonics Italy	Italy
Fortier	Coraline	Institut Carnot de Bourgogne (ICB) CNRS-UB Dijon	France
Foursa	Dmitri	Tyco Telecommunications	U.S.A.
Francois	Plerre	UCLouvain	Belgium
frandino	anastasia	stilema	Italy
Franz	Bernd	Alcatel-Lucent Deutschland AG	Germany
Freude	Wolfgang	Institute of High-Frequency and Quantum Electronics	Germany
Freund	Ronald	Fraunhofer Institut für Nachrichtentechnik - Heinrich Hertz Institut	Germany
Friedrich	Giorgio	Reichle & De-Massari AG	Switzerland
Frignac	Yann	Institut TELECOM, TELECOM & Management SudParis	France
Fu	Shao-Wei	Reflex Photonics Inc.	Canada
Fugang	Zheng	HUAWEI TECHNOLOGIES Co.LTD	China
Fujii	Yoichi	Nihon Univeresity	Japan
Fujiwara	Takumi	Tohoku University	Japan
Fujiwara	Toshihito		Japan
Fukada	Kota	WasedaUniversity	Japan
Fukada	Youichi	NTT	Japan
Fukuchi	Yutaka	Tokyo University of Science	Japan
Fukuda	Mitsuo	Toyohashi University of Technology	Japan
Fukuoka	Masayasu	Yokohama National University	Japan
Fumiyoshi	Kano	NTT Photonics Laboratories	Japan

Fürst	Cornelius	Ericsson	Germany
Furukawa	Hideaki	National Institute of Information and Communications Technology	Japan
Gaberl	Wolfgang	Vienna University of Technology	Austria
Gabet	Renaud	Telecom Paritech	France
Gaete	Oscar	Technische Universität München	Germany
Gainov	Vladimir	Moscow Institute of Physics and Technology (State University)	Russian Federation
Galili	Michael	Technical University of Denmark	Denmark
Gambini	Piero	Avago Technologies	Italy
Gangloff	Eric	Institut TELECOM & Management SudParis	France
Garcia	Miguel-Angel	Fibernet	Spain
Garnache	Arnaud	Institut d'Electronique du Sud	France
Gasulla	Ivana	Universidad Politecnica de Valencia	Spain
Gaudino	Roberto	Istituto Superiore Mario Boella	Italy
Gavignet	Paulette	France Telecom R & D	France
Gavioli	Giancarlo	University College London	United Kingdom
Gay	Mathilde	CNRS FOTON	France
Geernaert	Thomas	Vrije Universiteit Brussel	Belgium
Geiger	Harald	Ericsson	Germany
Geisler	Tommy	OFS Fitel Denmark ApS	Denmark
Georis	Olivier	G-TEC	Belgium
Gerome	Frederic	XLIM	France
Gerstel	Ori	Cisco	Israel
Ghiggino	Pierpaolo	Ericsson	Italy
Giannone	Domenico	Multitel	Belgium
Gibbon	Tim	DTU Fotonik	Denmark
Giller	Robin	Intune Networks	Ireland (Rep.)
Ginis	Vincent		Belgium
Girault	Gwenaelle	CNRS UMR 6082	France
Gisin	Nicolas	University of Geneva	Switzerland
Gladisch	Andreas	T-Systems	Germany
Gladyshev	Alexey	Fiber Optics Research Center FORC RAS	Russian Federation
Gladysheva	Evgenia	FORC	Russian Federation
Gleeson	Liam	Ericsson	United Kingdom
Glick	Madeleine	INTEL	
Glorioso	Andrea	European Commission	Belgium
Gomatam	Badri	Vitesse Semiconductor	United States of America
Gomes	Anderson	UFPE	Brazil
Gosselin	Stéphane	Orange Labs, France Telecom R&D	France
Goto	Akio	NEC Corporation	Japan
Gracie	Christopher	SOA	United Kingdom
Grallert	Hans-Joachim	Heinrich-Hertz-Institute	Germany
Grard	Emmanuel	3S PHOTONICS	France
Greco Polito	Silvana	IDA	Germany

Greg	May	Bookham Technology	United Kingdom
Grellier	Edouard	Alcatel-Lucent	France
Griesser	Helmut	Ericsson	Germany
Griffin	Robert		United Kingdom
Grignard	Patrick	no	Belgium
Grillet	Christian	CUDOS	Australia
Grue	Aden	University of Alberta	Canada
Grüner-Nielsen	Lars	OFS Denmark	Denmark
Grupp	Wolfgang	JDSU Deutschland GmbH	Germany
Guanshi	Qin	TOYOTA TECHNOLOGICAL INSTITUTE	Japan
Guerrero Gonzalez	Neil	Technical University of Denmark	Denmark
Gunning	Fatima	Tyndall National Institute	Ireland (Rep.)
Guo	Hongxiang	KDDI R&D Laboratories, Inc.	Japan
Guy	Martin	TeraXion	Canada
Hagimoto	Kazuo	NTT	Japan
Hagley	Edward	Acadia Optronics LLC	U.S.A.
Halbe	Kilian	DIAMOND GmbH	Germany
Hall	Trevor	University of Ottawa	Canada
Hamaide	Jean-Pierre		France
Hamamoto	Kiichi	Kyushu university	Japan
Hamilton-Smith	Michael	Mintera Corporation	United Kingdom
Hampton	Beth	OSA	United States of America
Han	Sang-Kook	Yonsei University	Korea
Han	steven	Post&telecommunication research institute	China
Han	Won-Taek	Gwangju Institute of Science and Technology	Korea
Hanik	Norbert	Technische Universität München	Germany
Hansen Mulvad	Hans Christian	Technical University of Denmark / DTU Fotonik	Denmark
Hansryd	Jonas	Ericsson AB	Sweden
Hara	Kazutaka		Japan
Harai	Hiroaki	National Institute of Information and Communications Technology (NICT)	Japan
Harder	Christoph	HPP	Switzerland
Harper	Paul	Aston University	United Kingdom
Harris	Richard	ADVA Optical Networks	U.S.A.
Harvey	John	University of Auckland	New Zealand
Hasegawa	Hideaki	The Furukawa Electric Co. LTD.	Japan
Hasegawa	Hiroshi	Nagoya University	Japan
Hatakoshi	Gen-ichi	JST	Japan
Hauske	Fabian	University of the Federal Armed Forces, Munich	Germany
Hautakorpi	Markus	Helsinki University of Technology	Finland
Hayashi	Hiroaki	Hitachi, Ltd., Central Research Laboratory	Japan
Hayashi	Michiaki	KDDI R&D Laboratories Inc.	Japan
Hayashi	Rie	NTT	Japan
He	Jianfei	HUAWEI TECHNOLOGIES	China

He	Zuyuan	University of Tokyo	Japan
Hegers	Andreas	Nortel	Germany
Heidemann	Rolf	Ulm University	Germany
Heismann	Fred	JDSU	U.S.A.
Henri	Pascal	Alcatel-Lucent, Bell Labs	France
Herbst	Stefan	Ericsson	Germany
Herrera Llorente	Javier	Universidad Politécnica de Valencia	Spain
Herve	Gouraud	Photline Technologies	France
Herwig	Kogelnik	Alcatel-Lucent	U.S.A.
Hibino	Yoshinori	NTT	Japan
Hill	Martin	Eindhoven University of Technology	Netherlands
Hinderthür	Henning	ADVA AG Optical Networking	Germany
Hirooka	Toshihiko	Tohoku University	Japan
Hiroshi	Kajioka	Global Fiberoptics Ltd	Japan
Hirotake	Oomori	Sumitomo Electric Industries	Japan
Hoang Yan	Lin	National Taiwan University	Taiwan R.O.C.
Hodara	Henri		U.S.A.
Hofer	Christoph	Siemens AG	Austria
Hohenbichler	Michael	European Commission	Belgium
Holtmannspoetter	Michael	F.-A.-University of Erlangen-Nuremberg	Germany
Hong	Moon-Ki	Yonsei University	Korea
Hong	Xiaobin	Beijing University of Posts and Telecommunications (BUPT)	China
Hongyan	Fu	Zhejiang University	China
Hooper	Richard	DS Air Publications	United Kingdom
Horbitt	Yu	HUAWEI	China
Horita	Masayoshi	FiberLabs, Inc.	Japan
Horiuchi	Yukio	KDDI R&D Laboratories	Japan
Houghton	Andrew	European Commission	Belgium
Hoving	Willem	XiO Photonics	Netherlands
Hu	Hao	Tianjin University	China
Huang	Jason	Huawei	China
Huebel	Hannes	University of Vienna	Austria
Hula	Miloslav	CESNET, z.s.p.o.	Czech Republic
Huybrechts	Koen	Ghent University	Belgium
Hwang	Sung Hwan	Korea Photonics Technology Institute	Korea
Ibrahim	Selwan	Tyndall National Institute	Ireland (Rep.)
Ichibangase	Hiroshi	Mitsubishi Electric Corp.	Japan
Ichida	Takehito		Japan
Ichihara	Wataru	NTT Communications Corporation	Japan
Idelfonso	Tafur Monroy	Technical University of Denmark	Denmark
Igarashi	Koji	University of Tokyo	Japan
Ignacio	de Miguel	Universidad de Valladolid	Spain
Ikeda	Jiro	Advanced Cable Systems Corp.	Japan

Ikezawa	Katsuya	Yokogawa Electric Corporation	Japan
Ikuma	Yuichiro	Keio University	Japan
Im	Youngmin	Korea Electronics Technology Institute	Korea, Republic of
Imaizumi	Hideaki	The University of Tokyo	Japan
Imamura	Hideki	NTT-EAST	Japan
Imamura	Katsunori		Japan
Inniss	Daryl		U.S.A.
Inoue	Hiroaki	Opnext Japab, Inc	Japan
Inoue	Ichiro	NTT	Japan
Inoue	Kent	Kogyo Tsushin Co., Ltd	Japan
Inoue	Osamu	NTT	Japan
Ioannis	Papagiannakis	University of Patras	Greece
Ishihara	Koichi	NTT Corporation	Japan
Ishii	Futoshi	Kohoku Kogyo Co., Ltd.	Japan
Ishii	Kiyo	Nagoya University	Japan
Ishii	Yuzo	NTT Coreporation	Japan
Ishikawa	Hiroshi	National Institute of Advanced Industrial Science and Technology (AIST)	Japan
Ishimura	Katsuhiko	OF Networks Co., Ltd	Japan
Isono	Kenji	KOGENT, Inc.	Japan
Itaya	Yoshio	NTT	Japan
Ito	Katsuyoshi	Toyo University	Japan
Ito	Toshiharu	NEC Corporation	Japan
Itoh	Mikitaka	NTT	Japan
Itsuro	Morita	KDDI R&D laboratories	Japan
Iyer	Rajiv	Reflex Photonics Inc.	Canada
Izutsu	Masayuki	Tokyo Institute of Technology	Japan
Jacob	Yaron	ECI Telecom	Israel
Jacobsen	Gunnar	Acreo AB	Sweden
James	Robb	Infinera	U.S.A.
Jamshidifar	Mehdi	Swansea University	United Kingdom
Jänes	Peter	Proximion Fiber Systems AB	Sweden
Janicki	Krzysztof	Comarch	Poland
Jansen	Sander	Nokia Siemens Networks GmbH & Co. KG	Germany
Jaouen	Yves	TELECOM ParisTech	France
Jasapara	Jayesh	OFS Laboratories	U.S.A.
Jean Francois	BRU	iXCore	France
Jenkins	Brian	US Naval Academy	U.S.A.
Jensen	Jesper	Technical University of Denmark	Denmark
Jeppesen	Palle	Technical University of Denmark	Denmark
Jiang	Wen-Jr	National Chiao Tung University	Taiwan R.O.C.
Jinno	Masahiko		Japan
John	Smith	Eudyna Devices	U.S.A.
Joindot	Michel	ENSSAT	France

Jones	Gareth	Ericsson	United Kingdom
Jones	Howard	BCS Public Relations	United Kingdom
Ju	Seongmin	Gwangju Institute of Science and Technology	Korea, Republic of
Jung	Hyun-Do	Eindhoven University of Technology	The Netherlands
Jurin	Goran	Croatian telecommunications Agency	Croatia
Jurkovic	Boris	Iskratel d.o.o.	Slovenia
Kai	Yutaka	Fujitsu Laboratories Ltd.	Japan
Kaino	Toshikuni	Tohoku University	Japan
Kajioka	Hiroshi	Global Fiberoptics, Ltd.	Japan
Kalbe	Gustav	european commission	Belgium
Kaliteevskiy	Nikolay	Corning	Russian Federation
Kamijoh	Takeshi	Oki Electric Industry Co., Ltd.	Japan
Kanda	Yoshihiro	OKI Electric Industry	Japan
Kaneko	Akimasa	NTT	Japan
Kaneko	Shin	NTT Corporation	Japan
Kang	Inuk	Alcatel-Lucent	U.S.A.
Kang	Moonsoo	Chosun University	Korea
Kang	Sae-Kyoung	ETRI	Korea, Republic of
Karalekas	Vasileios	Photonics Research Group, Aston University	United Kingdom
Karasek	Miroslav	CESNET, z.s.p.o.	Czech Republic
Karlsson	Magnus	Chalmers University of Technology	Sweden
Kashiwagi	Ken	The University of Tokyo	Japan
Kataoka	Nobuyuki	National Institute of Information and Communications Technology	Japan
Kato	T		Japan
Kato	Tomoyuki	Tokyo Institute of Technology	Japan
Katrami	Anna	European Commission	Belgium
Katsaros	George	E Katsaros SA	Greece
Kauffels	Franz Joachim	Vogel Verlag	Germany
Kawanishi	Tetsuya	National Institute of Information and Communications Technology	Japan
Kawashima	Hiroshi	The Furukawa Electric Co., Ltd.	Japan
Kazmierski	Christophe	Alcatel-Thales III-V Lab	France
Kazovsky	Leonid	Stanford University	Denmark
Kazuyoshi	Watanabe	Hikari Inc.	Japan
Kehayas	Efstratios	Institute of communication and Computer Systems	Greece
Keil	Norbert	Fraunhofer Institute for Telecommunications	Germany
Keil	Ulrich		Denmark
Keiser	Matthew	Northrop Grumman	U.S.A.
Khan	Saad	Santec Corporation	Japan
Khoe	Djan	COBRA - TUEindhoven	The Netherlands
Kikuchi	Kazuro	University of Tokyo	Japan
Kikuchi	Nobuhiko	Hitachi Ltd., Central Res. Lab.	Japan
Kilper	Daniel	Alcatel-Lucent	U.S.A.
Kim	Dong Churl	ETRI	Korea (south)

Kim	J.D.		Korea, Republic of
Kim	Jongbae	ETRI	Korea, Republic of
Kim	Jonghoi	ETRI	Korea
Kim	Ju-Seong	Electronics and Telecommunications Research Institute	Korea, Republic of
Kim	Kwangjoon	ETRI	Korea (south)
Kindermans	Guy	Data News	Belgium
Kirstädter	Andreas	University Stuttgart	Germany
Kish	Fred	Infinera	U.S.A.
Kitayama	Ken-ichi	Osaka University	Japan
Kjaer	Rasmus	DTU Fotonik	Denmark
Kliros	George	Hellenic Air-Force Academy	Greece
Klonidis	Dimitrios	Athens Information Technology Centre	Greece
Kobayashi	Akane	Waseda University	Japan
Kobayashi	Kohroh	Tokyo Institute of Technology	Japan
Kobayashi	Koichi	Bright Consulting Inc.	Japan
Kobayashi	Naoto	AIST (National Institute of Advanced Industrial Science and Technology)	Japan
Kockaert	Pascal	Université libre de Bruxelles	Belgium
Koike	Yasuhiro	Keio University/JST ERATO-SORST	Japan
Kokubun	Yasuo	Yokohama National University	Japan
Koonen	Ton	COBRA - TUEindhoven	The Netherlands
kopp	christophe	CEA-Leti MINATEC	France
Koshikiya	Yusuke	NTT Corporation	Japan
kosugi	tomoya	Keio University	Japan
Kotaka	Kazunori	New Energy and Industrial Technology Development Organization	Japan
Kotanigawa	Takashi	NTT corporation	Japan
Kourtessis	Pandelis	University of Hertfordshire	United Kingdom
Koyanagi	Satoshi	Furukawa Electric	Japan
Kraehenbuehl	Roger	HUBER+SUHNER	Switzerland
Krimmel	H.G.	Alcatel-Lucent Deutschland AG	Germany
Kringlebotn	Jon Thomas	Optoplan AS	Norway
Kristiansson	Anna	Ericsson AB	Sweden
Kroh	Marcel	u2t Photonics AG	Germany
Krongold	Brian	The University of Melbourne	Australia
Krummrich	Peter	Dortmund University of Technology	Germany
Kuiken	Hendrik	Hemmink B.V.	The Netherlands
Kuipers	Laurens	FOM-Institute AMOLF	The Netherlands
Kumar Goud Manikonda	Santhosh		Belgium
Kuppe	Johannes	AT-Fachverlag GmbH	Germany
Kurata	Kazuhiko	NEC corporation	Japan
Kurosu	Takayuki	National Institute of Advanced Industrial Science and Technology (AIST)	Japan
Kuschnerov	Maxim	University of the Federal Armed Forces, Munich	Germany
Kuwahara	Hideo	Fujitsu Laboratories Ltd.	Japan
Kwaaitaal	Jacco	COBRA - TUEindhoven	The Netherlands

Kwon	Dojoong	HANWHA CORPORATION GUMI PLANT	Korea
Kwon	O Kyun	ETRI	Korea (south)
Kyriacos	Kalli	Cyprus University of Technology	Cyprus
La Fauci	Domenico	Cisco Photonics Italy	Italy
Laenge	Roman	JDSU Deutschland GmbH	Germany
Lagasse	Paul	Ghent University - IBBT	Belgium
Lahodny	Scott	RSoft Design Group	U.S.A.
Lai	Caroline	Columbia University	U.S.A.
Lain	Jose M.	TELNET Redes Inteligentes, S.A.	Spain
Lambkin	John	Firecomms	Ireland
Landmark	Lars	Electronics and Telecommunication	Norway
Lange	Christoph	T-Systems Enterprise Services GmbH	Germany
Lannoo	Bart	Ghent University - IBBT	Belgium
Lanticq	Vincent	Electricite De France R&D	France
Larsen	Claus	Acreo	Sweden
Lazaro	José Antonio	UPC	Spain
Le	Quan	Electronics and Telecommunication Research Institute	Korea
Le Cren	Elodie	The University of Auckland	New Zealand
Le Kerneç	Arnaud	Thales Alenia Space	France
Le Masson	Jérôme	Orange Labs, France Telecom R&D	France
Lebby	Michael	oida	United States of America
Lee	Benjamin	Columbia University	U.S.A.
Lee	Chung Ghiu	Chosun University	Korea
Lee	Even	SWT	China
Lee	Han Hyub	Electronics and Telecommunications Research Institute	Korea
Lee	J.C.		Korea
Lee	J.K.		Korea
Lee	Liangchuan	ShenZhen Huawei Technologies Software Co., Ltd.	China
Lee	Steven	ICL/ITRI	Taiwan R.O.C.
Leeb	Walter	Vienna University of Technology	Austria
Lefevre	Herve	iXCore	France
Leminiaux	Christian	UTT	France
Lenardic	Borut	Optacore d.o.o.	Slovenia
Leonberger	Fred	EOvation Technologies, LLC	U.S.A.
Lepers	Catherine	Laboratoire PhLAM	France
Leplingard	Florence	Alcatel-Lucent, Bell Labs	France
Leppla	Ralph	Deutsche Telekom AG	Germany
Leuthold	Juerg	High Frequency and Quantum Electronics	Germany
Levy	David	General Dynamics	U.S.A.
Li	Jie	Acreo AB	Sweden
Li	Ming	Peking University	China
Li	Ruoding	Sycamore Networks	U.S.A.
Li	Xixiang	Huawei Technologies	China

Liang	Li	HUAWEI	China
Lichtenstein	Norbert	Bookham	Switzerland
Lim	Han Chuen	The University of Tokyo	Japan
Limberger	Hans-Martin	Swiss Federal Institute of Technology Lausanne (EPFL)	Switzerland
Lin	Chinlon	Nanyang Technological University	Singapore Rep. of
Lin	Chun-Ting	National Chiao Tung University	Taiwan R.O.C.
Lin	Yu-Min	ITRI	Taiwan R.O.C.
Linke	Richard	IEEE-Lasers & Electro-Optics Society	U.S.A.
Linkov	Dmitry	Institute of Contemporary IT	Russian Federation
Little	Brent	Infinera Corp	U.S.A.
Liu	Lei	Beijing University of Posts and Telecommunications (BUPT)	China
Liu	Ling	Fujitsu R & D Center Co., Ltd.	China
Liu	Liu	INTEC/Ghent University	Belgium
Liu	Yong	University of Electronic Science & Technology of China	China
Liu	Zhixin	Shanghai Jiao Tong University	China
Llorente	Roberto	Universidad Politecnica de Valencia	Spain
Lobanov	Sergey	Corning	Russian Federation
Lopez	Eduardo	UPC	Spain
Lord	Andrew	BT	United Kingdom
Louchet	Hadrien	VPIsystems	Germany
Loukina	Tatiana	Platform PERDYN	France
Lourdiane - Abib	Mounia	Institut TELECOM, TELECOM & Management SudParis	France
Lowery	Arthur	Monash University	Australia
Lu	Guo-Wei	National Institute of Information and Communications Technology	Japan
Lu	Ping	Communications Research Centre Canada	Canada
Luca	Massimo	Phasoptx	Canada
Lucas-Leclin	Benjamin	Anritsu Instruments SAS	France
Ludvigsen	Hanne	Helsinki University of Technology	Finland
Luisoni	Marco	Diamond SA	Switzerland
Lumish	Stan	Lumish Technology Consulting, LLC	U.S.A.
Lundstrom	Carl	Chalmers University of Technology	Sweden
Lundström	Carl	Chalmers University of Technology	Sweden
Luyckx	Geert	Ghent University	Belgium
Luzhansky	Edward	University of Maryland	U.S.A.
Lyubomirsky	Ilya	University of California	U.S.A.
Macar	Vesna	Telekom Srbija	Serbia and Montenegro
Mack	John	University of California at Santa Barbara	U.S.A.
Maeda	Wakako	NEC Corporation	Japan
Maeda	Y		United Kingdom
Magill	Peter	AT&T Labs	U.S.A.
Mahgerefteh	Daniel	Finisar	United States of America
Mahieu	Marc	TEXPRESS	Belgium
Makovejs	Sergejs	University College London	United Kingdom

Malacarne	antonio	Scuola Superiore Sant'Anna	Italy
Mamyshev	Pavel	Mintera corporation	U.S.A.
Mandelbaum	Mendel	Hebrew University Jerusalem	Israel
Manning	Robert	Tyndall National Institute	Ireland (Rep.)
Marceaux	Alexandre	THALES AIR SYSTEMS	France
Marhic	Michel	Swansea University	United Kingdom
Marini	Franco	ENEL Distribuzione S.p.A.	Italy
Martelli	Paolo	CoreCom	Italy
Martins	Evely	Ericsson GmbH	Germany
Masahiro	Yamaji	New Glass Forum	Japan
Mateo	Eduardo	CREOL. University of Central Florida	U.S.A.
Matrakidis	Chris	University of Peloponnese	Greece
Matsumoto	Masayuki	Osaka University	Japan
Matsuo	Shoichiro	Fujikura Ltd.	Japan
Matsuoka	Shinji	NTT Network Innovation Labs.	Japan
Matsushima	Yuichi	NICT, Japan	Japan
Mattila	Marco	Luxdyne Ltd	Finland
May	Greg	Bookham Technology	United Kingdom
Mazzochi	Hector	Prysmian S.p.A.	Italy
McCarthy	Mary	Tyndall National Institute	Ireland (Rep.)
McCool	Roshene	The University of Manchester	United Kingdom
Meersman	Raf		Belgium
Megret	Patrice	FACULTE POLYTECHNIQUE DE MONS	Belgium
Mekada	Naoyuki	Santec Corporation	Japan
Mekonnen	Gebre-Giorgis	Fraunhofer Institute / Heinrich Hertz Institute	Germany
Melloni	Andrea	Politecnico di Milano	Italy
Menth	Michael	Universität Würzburg	Germany
Merlaud	Fabien	FRANCE TELECOM	France
Merlet	Thomas	THALES AIR SYSTEMS	France
Mersh	Robin	The Broadband Forum	Market Focus Speaker
Mettler	Stephen	Me	U.S.A.
Mezzarobba	Emiliano	Zinwave Ltd	United Kingdom
Mignani	Anna Grazia	IFAC-CNR	Italy
Mikhailov	Vitaly	University College London	United Kingdom
Mimura	Yu	The Furukawa Electric Co., Ltd.	Japan
Ming-Fang	Huang	Georgia Institute of Technology	U.S.A.
Miura	Masayuki	The Furukawa Electric Co., Ltd.	Japan
Miyauchi	Akira	fujitsu	Japan
Miyazaki	Tetsuya	NICT	Japan
Miyoshi	Yuji	Osaka University	Japan
Mizrahi	Daniel	FAE	Israel
Mizumoto	Tetsuya	Tokyo Institute of Technology	Japan
Mizuno	Yosuke		Japan

Monat	Christelle	University of Sydney	Australia
Monteiro	Manuel	European Commission	Belgium
Monteiro	Paulo	Nokia Siemens Networks Portugal, S.A.	Portugal
Monti	Paolo	The University of Texas at Dallas	U.S.A.
Moon	Jung-Hyung	Photonic Networks Research Laboratory Dept. Of EECS	Korea
Mori	Masahiko	National Institute of Advanced Industrial Science and Technology (AIST)	Japan
Mori	Takashi	Anritsu Corporation	Japan
Mori	Yojiro	The University of Tokyo	Japan
Morita	Yasuaki	Nagoya University	Japan
Morlion	Birgit	IBBT	Belgium
Morohashi	Isao	National Institute of Information and Communications Technology	Japan
Morthier	Geert	INTEC/Ghent University	Belgium
Moss	David	The University of Sydney	Australia
Mumtaz	Sami	Institut TEECOM - TELECOM ParisTech	France
Mur	Jean-Michel		France
Murakami	Koso	Osaka University	Japan
Muramoto	Yoshifumi	NTT Corporation	Japan
Murdoch	Stuart	The University of Auckland	New Zealand
Murphy	Ed	JDSU Corp.	United States
Muthirayan	Buvaneshwari		Belgium
Mwaniki	Robert	universal media research	Kenya
Myara	Mikhael	Institut d'Electronique du Sud - Université Montpellier II	France
Mykkeltveit	Anders	Norwegian University of Science and Technology	Norway
Myren	Sverre Konrad	Nexans Norway AS	Norway
Nagaeda	Hiroshi	Trimatiz Limited	Japan
Nakagami	Takakiyo	Kanagawa Institute of Technology	Japan
Nakagawa	Naoki	Osaka University	Japan
Nakajima	Hirochika	Waseda University	Japan
Nakamura	Moriya	National Institute of Information and Communications Technology	Japan
Nakamura	Roberto	Padtec SA	Brazil
Nakamura	Shigeru	NEC Corporation	Japan
Nakano	Yoshiaki	The University of Tokyo	Japan
Nakashima	Hisao	Fujitsu Laboratories Ltd.	Japan
Nakatsuhara	Katsumi	Kanagawa Institute of Technology	Japan
Nakazawa	Masataka	Tohoku University	Japan
Namiki	Junji	Tokai University	Japan
Namiki	Shu	National Institute of Advanced Industrial Science and Technology (AIST)	Japan
Naniy	Oleg	Hihg Technology Publishers Ltd.	Russian Federation
Nasilowski	Tomasz	Vrije Universiteit Brussel	Belgium
Nasu	Hideyuki	The Furukawa Electric Co., Ltd.	Japan
Nebendahl	Bernd	Agilent Technologies	Germany
Neidlinger	Stephan	ADVA Opt. Networking, Cam. Martinsried	Market Focus Speaker
Neri	Fabio	Politecnico di Torino	Italy

Nesset	Derek		United Kingdom
Ng	Trina	University of Southampton	United Kingdom
Ngo	Minh Nguyet	CNRS UMR 6082 FOTON Labs	France
Ng'oma	Anthony	Corning Incorporated	U.S.A.
Nguyen	Anh Tuan	Université libre de Bruxelles	Belgium
Nguyen	Thanh Nam	ENSSAT - Foton	France
Nicholson	Jeffrey		U.S.A.
Nicolaisen	Ejner	Technical University of Denmark	Denmark
Niederberger	Ralph	Forschungszentrum Jülich	Germany
Nihei	Hiroyuki	Health Sciences University of Hokkaido	Japan
Niikura	Koji	Sumitomo Electric Industries,LTD	Japan
Nijhof	Jeroen	Ericsson	United Kingdom
Nijman	Wim	Consultant	The Netherlands
Nikles	Marc	Omnisens	Switzerland
Nikodem	Michal	Wroclaw University of Technology	Poland
Nobuhiro	Kituchi	Ntt photonics laboratories	Japan
Nobuhiro	Kituchi	NTT Photonics Laboratories	Japan
Noe	Reinhold	Universität Paderborn	Germany
Nölle	Markus	Fraunhofer Institut für Nachrichtentechnik - Heinrich Hertz Institut	Germany
Nonaka	Koji	Kochi University of Technology	Japan
Nowacki	Krzysztof	Telekomunikacja Polska	Poland
Nuccio	Scott	University of Southern California	U.S.A.
Nuijts	Roeland	SURFnet BV	The Netherlands
Nussman	Stefan		Germany
Obafemi	Abiodun Olumuyiwa	OLU OBAFEMI VENTURES	Nigeria
Oberland	Richard	Xtera Communications	United Kingdom
Ohara	Seiki	Asahi Glass Co., Ltd.	Japan
Ohara	Takuya	AT&T Labs - Research	U.S.A.
Ohashi	Keishi	NEC Corporation	Japan
Ohishi	Yasutake	Toyota Technological Institute	Japan
Ohlen	Peter	Ericsson Research	Sweden
Okada	Norio	Mitsubishi Electric Corporation	Japan
Okamoto	Aisuke	Shin-Etsu Chemical	Japan
Okamoto	Katsunari	AiDi Corporation	Japan
Okamoto	Keiji	NTT Corporation	Japan
Okamoto	Satoru	Department of Information and Computer Science	Japan
Okamura	Keisuke	Fujikura Ltd.	Japan
Okazaki	Masatada	Tohoku University	Japan
Oliveira Pires	Joao Jos	Instituto de Telecomunicações	Portugal
Olsson	Bengt-Erik	Ericsson AB	Sweden
Omella	Mireia	UPC	Spain
Onaka	Hiroshi	Fujitsu Ltd.	Japan
Onishi	Yutaka	Sumitomo Electric Industries, LTD.	Japan

Ono	Takashi	NTT	Japan
Osadchiy	Alexey	Technical University of Denmark	Denmark
Ossieur	Peter	Ghent University	Belgium
O'Sullivan	Maurice	nortel	Canada
Ota	Ikuo	FURUKAWA ELECTRIC	Japan
Oyamada	Hiroshi	Shin-Etsu Chemical Co., Ltd.	Japan
Ozeki	Takeshi	Sophia University	Japan
Pachnicke	Stephan	Dortmund University of Technology	Germany
Painchaud	Yves	TeraXion	Canada
Palmieri	Luca	University of Padova	Italy
Papakos	Kim	Tellabs	USA
Park	Jung Hyun	IITA	Korea
Park	Mirna	ETRI	Korea (south)
Park	Sang-Ho	ETRI	Korea
Park	Yongwoo	INRS-EMT	Canada
Parmigiani	Francesca	University of Southampton	United Kingdom
Patterson	David	General Dynamics	U.S.A.
Pavlova	Elena	Hihg Technology Publishers Ltd.	Russian Federation
Payne	David	University of Southampton	United Kingdom
Peach	Matthew	Photonics KTN	United Kingdom
Pearsall	Thomas	EPIC	France
Pelacho	Silvia	TELNET Redes Inteligentes, S.A.	Spain
Pellevrault	Sébastien	Supelec	France
Pelusi	Mark	The University of Sydney	Australia
Peng	Miao	southeast university,china	China
Penty	Richard	University of Cambridge	United Kingdom
Pepeljugoski	Petar	IBM	U.S.A.
Perello	Jordi	Universitat Politècnica de Catalunya (UPC)	Spain
Perry	Philip	Dublin City University	Ireland (Rep.)
Petermann	Klaus	TU Berlin	Germany
Peterson	Christopher	Alphion Corporation	U.S.A.
Peucheret	Christophe	Technical University of Denmark	Denmark
Pezeshki	Bardia	Santur	United States of America
Pfau	Timo	University of Paderborn	Germany
Pfeiffer	Thomas	Alcatel-Lucent Deutschland AG	Germany
Philippe	Beno	W-TCA	Belgium
Phillips	Ian	Ericsson	United Kingdom
Pickavet	Mario	IBBT - Universiteit Gent	Belgium
Piehler	David	Alphion	U.S.A.
Pikus	Branislav	Sylex, s.r.o.	Slovakia
Piqueras	Miguel	DAS PHOTONICS	Spain
Pitois	Stephane	Institut Carnot de Bourgogne, Universit? de Bourgogne	France
Piyawanno	Kittipong	University of the Federal Armed Forces, Munich	Germany

Pizzinat	Anna	France Télécom Research & Development	France
Pleros	Nikos	Intsitute of Communication & Computer Systems (ICCS) / National Technical University of	Greece
Poggiolini	Pierluigi	Politecnico di Torino	Italy
Poli	Federica	University of Parma	Italy
Polishuk	Paul	Information Gate Keeper Inc.	U.S.A.
Politi	Christina (Tanya)	University of Peloponnese	Greece
Polo	Victor	UPC Campus Nord Edif. D4	Spain
Poole	Simon	Optium Australia	Australia
Popov	Mikhail	Acreo AB	Sweden
Poti'	Luca	CNIT	Italy
Poustie	Alistair		United Kingdom
Prat	Josep	Universitat Politecnica de Catalunya (UPC)	Spain
Prati	Giancarlo	Scuola Superiore Sant'Anna	Italy
Presi	Marco	Scuola Superiore Sant'Anna	Italy
Pretty	Penny	Laurin Publ	United Kingdom
Pritchard	Tim	LIGHTWAVE; Lightwave Europe	U.S.A.
Provo	Richard	The University of Auckland	New Zealand
Provost	Lionel	Draka	France
Pu	Tianchun	Huawei Technologies Co., Ltd.	China
Puerto	Gustavo	Universidad Politecnica Valencia	Spain
Pun	Edwin	City University of Hong Kong	China
Put	Jasmien	Ghent University	Belgium
Qiu	Xing-Zhi	INTEC/Ghent University	Belgium
Rainsant	Jean-Marc	Alcatel-Lucent	France
Rajkovic	Predrag	CRONY	Serbia and Montenegro
Ramantanis	Petros	Institut TELECOM, TELECOM & Management SudParis	France
Randel	Sebastian	Siemens AG	Germany
Raspopovic	Dragutin	Telekom Serbia	Serbia and Montenegro
Raz	Oded	Eindhoven University of Technology	The Netherlands
Rees	Martin		United Kingdom
Reid	Douglas	Dublin City University	Ireland (Rep.)
Reid	John		The Netherlands
Renaudier	Jeremie	Alcatel-Lucent, Bell Labs	France
Riccardi	Emilio	Telecom Italia	Italy
Ricci	Gianluca	Ericsson - Marconi SpA	Italy
Richardson			United Kingdom
Richter	Andre	VPIsystems	Germany
Rietveld	Willy	Tyco Electronics Nederland B.V.	The Netherlands
Rigby	Pauline	IOP Publishing	United Kingdom
Rigole	Pierre-Jean	SYNTUNE	Sweden
Roberto	Vincenzo	Cisco Photonics Italy	Italy
Rocks	Manfred	T-Systems Enterprise Services GmbH	Germany
Roelandt	Stijn		Belgium

Roelens	Michael	The University of Sydney	Australia
Roelkens	Gunther	Ghent University - IMEC	Belgium
Rogério	Nogueira	Instituto de Telecomunicações	Portugal
Rohde	Michael	Technische Fachhochschule Berlin	Germany
Roldan Andrade	Jesus	European Patent Office	The Netherlands
Romagnoli	Marco	PGT Photonics	Italy
Rong	Hao	Engineer	China
Rosenkranz	Werner	University of Kiel	Germany
Roy	Rajesh	UC Davis	U.S.A.
Roy	Subhash	AMCC	U.S.A.
Rubenstein	Roy		Israel
Ruby	Paul	level 3 communications	United Kingdom
Ruderman	Kurt	lightwave magazine	France
Ryabushkin	Oleg	Institute of Radio-Engineering and Electronics of RAS	Russian Federation
Ryoichi	Akimoto	National Institute of Advanced Industrial Science and Technology (AIST)	Japan
Sabella	Roberto	Ericsson	Italy
Saerens	Dimitri	G-TEC	Belgium
Saitoh	Kunimasa	Hokkaido University	Japan
Sakai	Jun	NEC Corporation	Japan
Sakakibara	Youichi	AIST	Japan
Sakamoto	Takahide	National Institute of Information and Communications Technology (NICT)	Japan
Sakata	Yoshitaka	OLYMPUS CORPORATION	Japan
Sakauchi	Masahiro	NEC Corporation	Japan
Sakuma	Hisato	NEC Corporation	Japan
Salathé	René Paul	EPFL	Switzerland
Salauddin	Rashel	future IT solutions	Bangladesh
Sales	Salvador	Universidad Politecnica Valencia	Spain
Saliou	Fabienne	France Télécom Research & Development	France
Salomao	Jorge	Padtec	Brazil
Sambaraju	Rakesh	Universidad Politecnica de Valencia	Spain
Sandström	Hans-Eric		Sweden
Sano	Akihide	NTT Corporation	Japan
Sardesai	Harshad	Ciena Corporation	U.S.A.
Sartori	Francesco	Prysmian S.p.A.	Italy
Sartorius	Bernd	Fraunhofer Heinrich-Hertz-Institute	Germany
Sasaki	Takashi	Sumitomo Electric Industries Ltd.	Japan
Sato	Ken-ichi	Nagoya University	Japan
Sato	Kunihiro	Hokkai-Gakuen University	Japan
Saucez	Damien	UCL	Belgium
Savory	Seb	University College London	United Kingdom
Sawa	Takahiro	Kanagawa Institute of Technology	Japan
Saylors	Marshall	Laboratory For Physical Sciences	U.S.A.
Schaefer	Ralf	Fraunhofer HHI	Germany

Schaeffer	Christian	TU Dresden	Germany
Schell	Martin	Fraunhofer HHI	Germany
Schiano	Marco	Telecom Italia	Italy
Schinn	Gregory	EXFO Electro-Optical Engineering	Canada
Schmidt	Daniel	University of the Federal Armed Forces, Munich	Germany
Schmidt-Langhorst	Carsten	Fraunhofer Heinrich-Hertz-Institute	Germany
Schneider	Thomas	Hochschule für Telekommunikation	Germany
Schneiders	Malte	Deutsche Telekom AG	Germany
Schotman	Robertus	Hemmink B.V.	The Netherlands
Schrenk	Bernhard	UPC	Spain
Schuh	Karsten	Alcatel-Lucent Deutschland AG	Germany
Schuster	Matthias	Technische Universität Berlin	Germany
Schwartz	Joerg	Laurin Publ	Germany
Scolari	Lara		Denmark
Seimetz	Matthias	Fraunhofer Heinrich-Hertz-Institute	Germany
Seo	Dae Dong	HANWHA Corporation	Korea, Republic of
Serbay	Murat	MergeOptics	Germany
Serena	Paolo	University of Parma	Italy
Seto	Masaru	The FURUKAWA ELECTRIC co.,LTD	Japan
Shahine	M. H.	CIENA Corp.	U.S.A.
Shahram	Keyvaninia	Ghent University - IMEC	Belgium
Shcherbakov	Yury	Institute of Contemporary IT	Russian Federation
Shibata	Nori	National Institute of Advanced Industrial Science and Technology (AIST)	Japan
Shibutani	Makoto	NEC Corporation	Japan
Shiga	Noriyasu	Trimatiz .ltd	Japan
Shih	Po-Tsung		Taiwan R.O.C.
Shikada	Minoru	NEC Corporation	Japan
Shimayabu	Kohei	Hokkaido University - Research Group of Advanced Electronics	Japan
Shimizu	Kaori	NTT	Japan
Shimizu	Sho	Keio University	Japan
Shimo	Masashi	Sumitomo Osaka Cement Co.,Ltd.	Japan
shirasaka	yusei	fitel	Japan
Shoji	Hajime	Eudyna Devices Inc.	Japan
Shoji	Yuya	National Institute of Advanced Industrial Science and Technology (AIST)	Japan
Shore	Alan	Bangor University	United Kingdom
Shortland	Simon	DS Air Publications	United Kingdom
Shu	Chester	The Chinese University of Hong Kong	Hong Kong
Shukla	Vishnu	Verizon	U.S.A.
Shum			Singapore Rep. of
Silveira	Tiago	Nokia siemens Networks Portugal S.A.	Portugal
Sim	Yeow Kiat Kevin	Nanyang Technological University	Singapore Rep. of
Simeonidou	Dimitra	University of Essex	United Kingdom
Simon	Jean-Claude	FOTON-CNRS	France

Singh	Joginder	Level(3) Communications Limited	United Kingdom
Sinsky	Jeffrey	Bell Laboratories, Alcatel-Lucent	U.S.A.
Sirbu	Alexei	EPFL	Switzerland
Sitch	John	nortel	Canada
Skold	Mats	picosolve	Sweden
Smit	Meint	COBRA - TUEindhoven	The Netherlands
Smith	Christian	Aarhus University	Denmark
Solís-Trápala	Karen	COBRA - TUEindhoven	The Netherlands
Soto	Marcelo	Scuola Superiore Sant'Anna	Italy
Sova	Ray	Johns Hopkins Univsersity	U.S.A.
Spadaro	Salvatore	Universitat Politecnica de Catalunya (UPC) - Campus Nord	Spain
Spaeth	Jan	Ericsson	Germany
Spencer	Ralph	The University of Manchester	United Kingdom
Spiekman	Leo	Alphion Corp.	U.S.A.
Spinnler	Bernhard	Nokia Siemens Networks GmbH & Co. KG	Germany
Sponsel	Klaus	Institute of Optics,Information and Photonics	Germany
Spuesens	Thijs	Eindhoven University of Technology	The Netherlands
Staessens	Dimitri	Ghent University - IBBT	Belgium
Stahl	David	Nokia Siemens Networks	Germany
Stankovic	Stevan	Ghent University - IMEC	Belgium
Stasyuk	Vladimir	Pritel Inc	U.S.A.
Stavdas	Alexandros	University of Peloponnese	Greece
Steffan	Andreas	u2t Photonics AG	Germany
Stepniak	Grzegorz	Warsaw University of Technology	Poland
Stewart	Will	University of Southampton	United Kingdom
Strasser	Thomas	Nistica Inc	U.S.A.
Su	Yikai	Shanghai Jiao Tong University	China
Suberini	Luca	Alcatel-Lucent	Italy
Suche	Hubertus	Universität Paderborn	Germany
Sudbo	Aasmund	University of Oslo	Norway
Sugamata	Toru	SUMITOMO OSAKA CEMENT	Japan
Suh	Dongwoo	ETRI	Korea
Suh	Ho Suhng	Korea Research Institute of Standard and Science (KRISS)	Korea
Suh	Sam		U.S.A.
Sunnerud	Henrik	PicoSolve	Sweden
Suyama	Shigeki	NEC	Japan
Suzuki	Kenya	NTT Electronics Corp	Japan
Suzuki	Masahiro	NTT Network Innovation Laboratory	Japan
Suzuki	Masatoshi	KDDI R&D Laboratories	Japan
Suzuki	Naoki	Mitsubishi Electric Corporation	Japan
Suzuki	Senichi	NTT Photonics Laboratories	
Suzuki	Tetsuya	NTT Corporation	Japan
Svava Mortensen	Anders		Denmark

Swenson	Norman	ClariPhy Communications	United States of America
Sylvestre	Thibaut	Institut FEMTO-ST, Universit? de Franche-Comt	France
Sysak	Matthew	Intel Corporation	U.S.A.
Tada	Kunio	Kanazawa Institute of Technology	Japan
Tajima	Akio	NEC Corporation	Japan
Tajima	Tsutomu	NEC Corporation	Japan
Takahashi	Atsuya	NTT-AT	Japan
Takahashi	Hiroshi	NTT	Japan
Takahashi	Masanori	The Furukawa Electric Co., Ltd.	Japan
Takahito	Tanimura	Fujitsu Laboratories Ltd.	Japan
Takasaka	Shigehiro	Furukawa Electric Co., Ltd.	Japan
Takashima	Shigehiro	opnext japan, inc.	Japan
Takeda	Koji	The University of Tokyo	Japan
Takeda	Tomonori	NTT	Japan
Takenaga	Katsuhiko		Japan
Takeyoshi	Yusuke	Keio University	Japan
Takiguchi	Koichi	NTT Photonics Laboratories	Japan
Talli	Giuseppe	Tyndall National Institute/University College Cork	Ireland (Rep.)
Tan	XueSong	huawei	China
Tanaka	Akihiro	NEC Corporation	Japan
Tanaka	Shuhei	New Glass Forum	Japan
Tanemura	Takuo	University of Tokyo	Japan
Tanigawa	Shoji	Fujikura Ltd.	Japan
Taniguchi	Tomohiro	NTT Makuhari Bldg.	Japan
Tanimura	Takahito	Fujitsu Laboratories	Japan
Tassin	Philippe	Vrije Universiteit Brussel	Belgium
Tatsuno	Kimio	Hitachi, Ltd.,	Japan
Tavernier	Wouter	Ghent University - IBBT	Belgium
Tei	Daikou	Santec Corporation	Japan
Teipen	Brian	ADVA AG Optical Networking	Germany
Teixeira	Antonio	Instituto de Telecomunicações	Portugal
Tekin	Tolga	Fraunhofer IZM	Germany
Tesch	Tom	Ugent	Belgium
Testa	Francesco	Ericsson	Italy
Tetu	Michel	TeraXion	Canada
Thienpont	Hugo	Vrije Universiteit Brussel	Belgium
Thollabandi	Madhan	Gwangju Institute of Science and Technology (GIST)	Korea
Tian	Yue	Shanghai Jiao Tong University	China
Tibuleac	Sorin	ADVA Optical Networking	U.S.A.
Tode	Hideki	Osaka Prefecture University	Japan
Toffano	Zeno	Supelec	France
Togawa	Masayuki	manager of engineering	Japan
Tohmon	Genji	Emcore Corp	United States of America

Tokle		OFS Fitel Denmark	Denmark
Tokushima	Masatoshi	NEC Corporation	Japan
Tolstikhin	Valery	OneChip Photonics, Inc.	Canada
Tomita	Akihisa	Japan Science and Technology Agency - ERATO-SORST	Japan
Tomkos	Ioannis	RELIT-AIT	Greece
Tompane	Richard	Gemfire Corporation	U.S.A.
Tonello	Alessandro	XLIM - UMR CNRS n.6172	France
Toshikazu	Hashimoto	NTT	Japan
Townsend	Paul	Tyndall National Institute, University College Cork	Ireland
Tremblay	Christine	Ecole de technologie superieure - Universite du Quebec -ETS	Canada
Trita	Andrea	Università degli studi di Pavia	Italy
Tsai	Stanley S.Y.	Comoss Electronic. Co., Ltd	Taiwan
Tsuboi	Toshinori	Tokyo University of Technology	Japan
Tsuchida	Yukihiro	Hokkaido University	Japan
Tsuda	Hiroyuki	KEIO UNIVERSITY	Japan
Tsuritani	Takehiro	KDDI R&D Laboratories Inc.	Japan
Tucker	Rodney	University of Melbourne - CUBIN	Australia
Turitsyn	Sergei	Aston University	United Kingdom
Turley	Steve	3bridges consultancy	United Kingdom
Tutschku	Kurt	University of Vienna	Austria
Uchida	Teiji	Tokai University	Japan
Uda	Yoshihiro	NEC	Japan
Ueda	Hiromi	Tokyo University of Technology	Japan
Uehara	Noboru	Santec Corporation	Japan
Uenohara	Hiroyuki	Tokyo Institute of Technology	Japan
Umnikov	Andrey	Institute of chemistry of high-purity substances of the Russian Academy of Scien	Russian Federation
Unterbörsch	Günter	u2t Photonics AG	Germany
Urban	Patryk	Eindhoven University of Technology	The Netherlands
Urushidani	Shigeo	National Institute of Informatics	Japan
Utaka	Katsuyuki	Waseda University	Japan
Valdmanis	Janis	Picomatrix	United States of America
Valenta	Richard	OVE	Austria
Vallaitis	Thomas	University of Karlsruhe	Germany
van Bochove	Kees	KPN Royal Dutch Telecom	The Netherlands
Van Bogaert	Joeri	FTTH Council Europe	Belgium
Van Cleemputte	Werner	Medicongress	Belgium
Van Daele	Peter	IBBT - Universiteit Gent	Belgium
Van de Velde	Marie Claire	IBBT	Belgium
Van De Voorde	Ingrid	alcatel-lucent	Belgium
van den Hoven	Gerlas	Genexis	The Netherlands
Van Erps	Jurgen	Vrije Universiteit Brussel	Belgium
Van Hoe	Bram	University Ghent	Belgium
Van Ooteghem	Jose		Belgium

Van Thourhout	Dries	Ghent University - IMEC	Belgium
Vanderheijden	Jana		Belgium
Vandewege	Jan	Ghent University	Belgium
Vanhaverbeke	Jeroen		Belgium
Vassilieva	Olga	Fujitsu Laboratories of America, Inc.	U.S.A.
Vaudel	Olivier	CNRS UMR 6082 FOTON	France
Vaupel	Bernd	Deutsches Zentrum für Luft- und Raumfahrt	Germany
Vawter	Allen	Sandia National Laboratories	U.S.A.
Vedadi	Armand	Swansea University	United Kingdom
Vegas Olmos	J.J.	Osaka University - Dept. Of Electronic, Information and Energy Engineering	Japan
Veljanovski	Vladimir		Germany
Verbrugge	Sofie	UGent/IBBT	Belgium
Verma	Ashish	Finisar Corporation	U.S.A.
Vermeulen	Diedrik	Ghent University	Belgium
Verplancke	Nico	IBBT	Belgium
Veselka	John	CIENA Corp.	U.S.A.
Vetter	Peter	Alcatel-Lucent	Belgium
Veyres	Camille	VEYRES	France
Vidakovic	Nikola	Telekom Srbija	Serbia and Montenegro
Vijaya Saradhi	Chava	Create-Net	Italy
vincetti	luca	University of Modena and Reggio E.	Italy
Vitoret da Silva	Douglas	UFPE	Brazil
Vlasov	Yurii	IBM	United States of America
Vlekken	Johan	FOS&S	Belgium
Voet	Eli	Ghent University	Belgium
Voet	Marc	G-TEC	Belgium
Vogel	Wolfgang	Universitaet Stuttgart	Germany
Voigt	Robert		U.S.A.
Vorbeck	Sascha	Deutsche Telekom AG	Germany
Vorreau	Philipp	University of Karlsruhe	Germany
Vukovic	Alex	Communications Research Centre Canada	Canada
Waax	Jeannette	Fiber Optic Valley	Sweden
Wabnitz	Stefan	University of Brescia	Italy
Wada	Naoya	NICT	Japan
Wahl	Pierre		Belgium
Wakabayashi	Tomohiro	Yazaki Corporation	Japan
Wale	Mike	Bookham Technology plc	United Kingdom
Walewski	Joachim	Siemen AG, Corporate Technology CT IC 2	Germany
Walf	Godehard	Heinrich-Hertz-Institut, Fraunhofer Institut für Nachrichtentechnik	Germany
Walker	Stuart	University of Essex	United Kingdom
Wang	Haibo	University of Cambridge	United Kingdom
Wang	Jian	Huazhong University of Science & Technology	China
Wang	Jin	Institute of High-Frequency and Quantum Electronics	Germany

Wang	Jiqing	Axsun Technologies	U.S.A.
Wang	Tianliang	Tsinghua University	China
Wang	Ting	NEC Laboratories America	U.S.A.
Wang	Vincent	LUSTER LightTech Co.,Ltd	China
Wang	Weiyang	Huawei Technologies Co. Ltd.	Germany
Wang	Xu	Heriot Watt University	United Kingdom
Wang	Zhenzhong	Beijing University of Posts and Telecommunications (BUPT)	China
Wang	Zinan		U.S.A.
Warburton	Richard	Heriot-Watt	United Kingdom
Ware	Cedric	TELECOM ParisTech	France
Watanabe	Kei	Ntt Photonics Laboratories	Japan
Watanabe	Masanobu	National Institute of Advanced Industrial Science and Technology (AIST)	Japan
Watanabe	Yuji	Asahi Glass Co., Ltd.	Japan
Watts	Philip	University College London	United Kingdom
Way	Winston	Opvista	United States of America
Webb	David	Aston University	United Kingdom
Webb	Molly	The Climate Group	United Kingdom
Webb	Roderick	Tyndall National Institute/University College Cork	Ireland (Rep.)
Weber	Christian	Technische Universität Berlin	Germany
Weber	Markus	Fujitsu Microelectronics Europe	Germany
Weiss	Mario	Universität Duisburg-Essen	Germany
Weisser	Stefan	Alcatel-Lucent Deutschland AG	Germany
Weiwen	Zou	The University of Tokyo	Japan
Welch	Dave	Infinera	U.S.A.
Wellbrock	Glenn	Verizon	U.S.A.
Wenke	Gerhard	Hochschule Bremen	Germany
Westlund	Mathias	PicoSolve	Sweden
Westphal	F.-Joachim	T-Systems Enterprise Services GmbH	Germany
Whitbread	Neil	Bookham Technology plc	United Kingdom
Whiteaway	James	CoreOptics GmbH	Germany
Winter	Marcus	Technische Universität Berlin	Germany
Winzer	Peter	Alcatel-Lucent	U.S.A.
Wittenberg	Boaz	ECI Telecom	Israel
Won	Yong Hyub	Information and Communications University	Korea, Republic of
Wong	Kenneth Kin-Yip	The University of Hong Kong	Hong Kong
Wosinska	Lena	The Royal Institute of Technology KTH	Sweden
Wosinski	Lech	The Royal Institute of Technology KTH	Sweden
Wree	Christoph		U.S.A.
Wright	Andy	Infinera	U.S.A.
Wu	Chang-Cherng	National Chiao-Tung University	Taiwan R.O.C.
Wu	Jian	Beijing University of Posts and Telecommunications (BUPT)	China
Wu	Lorinda	Nelson Mandela Metropolitan University	South Africa
Wu	Xiaoxia	University of Southern California	U.S.A.

Wunderink	Martin	Department of the Air Force	U.S.A.
Xia	Chunmin	University of Kiel	Germany
Xiao	Shilin	Shanghai Jiaotong University	China
Xiaowei	Liu	CHINA	China
Xie	Changsong	Huawei Technologies CO. LTD.	Germany
Xie	Chongjin	Bell Labs, Alcatel-Lucent	U.S.A.
Xiong	Qianjin	Huawei technologies Co., LTD	China
Xu	Anshi	Peking University	China
Xu	Xiao Geng	ShenZhen Huawei Technologies Software Co., Ltd.	China
Yagi	Mikio	Softbank Telecom Corp.	Japan
Yamaguchi	Nobuhide	Fujitsu Limited	Japan
Yamamoto	Hiroshi	opnext japan, inc.	Japan
Yamamoto	Takashi	NTT Corporation	Japan
Yamamoto	Takuya	Nagoya University	Japan
Yamashita	Shinji	The University of Tokyo	Japan
Yamauchi	Osamu	NTT Corporation	Japan
Yamazaki	Etsushi	NTT corporation	Japan
Yamazaki	Hiroshi	NTT Corporation	Japan
Yamazaki	Norohiro	NTT EAST	Japan
Yan	Bin	China Mobile Communications Corporation	China
Yang	Hejie	Telecommunication Technology and Electromagnetics Technical University Eindhoven	The Netherlands
Yang	Jia	Eindhoven University of Technology	The Netherlands
Yasuoka	Nami	Fujitsu. Lab. LTD.	Japan
Yazaki	Tomonori	KDDI R&D Laboratories Inc.	Japan
Yeh	Chien-Hung	Industrial Technology Research Institute	Taiwan R.O.C.
Yin	Xin	INTEC/Ghent University	Belgium
Yin	Yawei	Beijing University of Posts and Telecommunications (BUPT)	China
Yokoyama	Yoshitaka	NEC Corporation	Japan
Yoo	S. J. Ben	University of California, Davis	U.S.A.
Yoshida	Junichi	Chitose Institute of Science & Technology	Japan
Yoshida	Masato	Research Institute of Electrical Communication	Japan
Yoshida	Nobuhide	NEC Corporation	Japan
Younce	Richard	Tellabs	U.S.A.
Yu	Jianjun	NEC Laboratories America	U.S.A.
Yukimatsu	Kenichi	AKITA UNIVERSITY	Japan
Zami	Thierry	Alcatel-Lucent	France
Zauner	Dan	Ignis Photonix A/S	Denmark
Zayets	Vadym	AIST (National Institute of Advanced Industrial Science and Technology)	Japan
Zeng	Jianming		The Netherlands
Zeng	Li	Huawei Technologies Co., Ltd.	China
Zeng	Lubin	University of Oxford	United Kingdom
Zervas	Georgios	University of Essex	United Kingdom
Zhang	Chao	The University of Tokyo	Japan

Zhang	Dejiang	HUAWEI TECHNOLOGIES CO.,LTD.	China
Zhang	Fan	Peking University	China
Zhang	Huijian	Fujitsu R&D Center CO., LTD.	China
Zhang	Jie	Beijing University of Posts and Telecommunications	China
Zhang	Lisa	Bell Labs	U.S.A.
Zhao	Y.	IUSTER IIGHT TECH	China
Zhaoguo	Ma	HUAWEI	China
Zheng	Xueyan	Finisar Corp	U.S.A.
Zhong	Shan	CIENA Corp.	U.S.A.
Zhou	Xiang	AT&T Labs-Research	U.S.A.
Zhou	Yuan	The University of Melbourne	Australia
Zhu	Xianming	Corning Incorporated	U.S.A.
Ziari	Mehrdad	Infinera	U.S.A.
Ziegler	Michael	European Commission	Belgium
Zimmermann	Lars	Technische Universität Berlin	Germany
Zontini	Mauro	Alcatel-Lucent Italia	Italy
Zouganeli	Evi		Norway
Zuccaro	Claudio	Nokia Siemens Networks GmbH & Co KG	Germany